

PCle® Technology in Al/ML: Maintaining High-Speed Connectivity

FMS 2025 Panel

August 2025



About Our Moderator



Al Yanes
PCI-SIG® President

Al Yanes has served as president of the PCI-SIG since 2003 and chairman since 2006 and is a Senior Technical Staff Member at IBM in the IBM FlashSystems Solutions group. He has 40 years of experience working with ASIC /FPGA designs in the I/O industry. Yanes holds 40+ patents for PCI™ and other I/O technologies. Yanes holds a B.S. in computer engineering from Rensselaer Polytechnic Institute.



PCI-SIG® Snapshot

- Organization that defines the PCI Express® (PCle®) I/O bus specifications and related form factors like the CopprLink™ Internal and **External Cables**
- PCI-SIG was established in 1992
- The PCle specification was first released in 2003
- Reached 1,000 member companies in Nov. 2024
- Creating specifications and mechanisms to support compliance and interoperability

Board of Directors 2025 - 2026















Qualcom

Silicon to Software



PCI Express[®] 7.0 Specification Now Available

PCIe® 7.0 Specification released to PCI-SIG Members on June 11, 2025

PCIe 7.0 Specification Key Features and Enhancements:

- Delivers 128.0 GT/s raw bit rate and up to 512 GB/s bi-directionally via x16 configuration
- Utilizes PAM4 (Pulse Amplitude Modulation with 4 levels) signaling and Flit-based encoding
- Provides improved power efficiency
- Maintains backwards compatibility with previous generations of PCIe technology



PCIe® 8.0 Specification Development Underway

The PCIe 8.0 specification is targeted for 2028

PCIe 8.0 Specification Target Features:

- Deliver 256.0 GT/s raw bit rate and up to 1 TB/s bi-directionally via x16 configuration
- Utilize PAM4 (Pulse Amplitude Modulation with 4 levels) signaling and Flit-based encoding
- Double frequency of PCIe 7.0 specification
- Maintain backwards compatibility with previous generations of PCIe technology
- Protocol enhancements

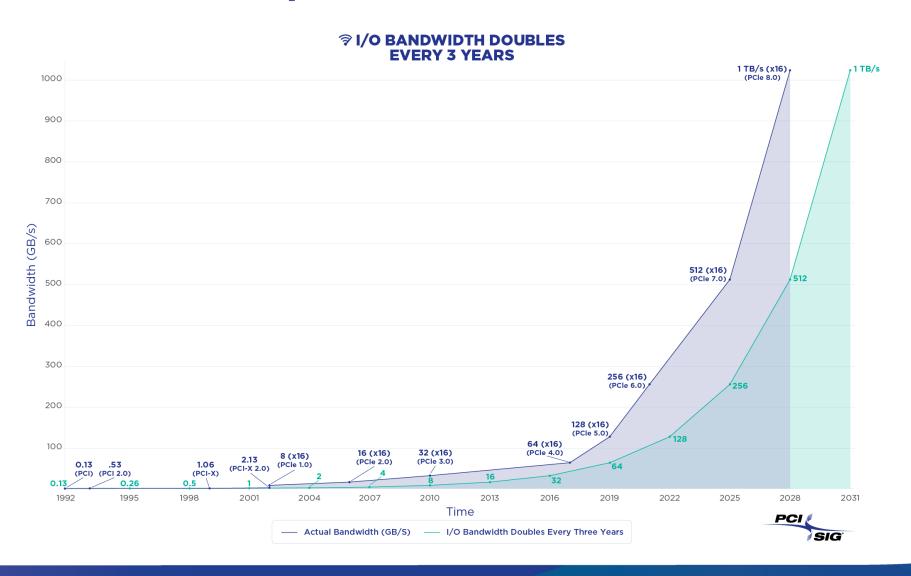
Revision**	Max Data Rate	Encoding	Signaling
PCIe 8.0 (2028)	256.0 GTs	1b/1b (Flit Mode*)	PAM4
PCIe 7.0 (2025)	128.0 GT/s	1b/1b (Flit Mode*)	PAM4
PCIe 6.0 (2022)	64.0 GT/s	1b/1b (Flit Mode*)	PAM4
PCIe 5.0 (2019)	32.0 GT/s	128b/130b	NRZ
PCIe 4.0 (2017)	16.0 GT/s	128b/130b	NRZ
PCIe 3.0 (2010)	8.0 GT/s	128b/130b	NRZ
PCIe 2.0 (2007)	5.0 GT/s	8b/10b	NRZ
PCIe 1.0 (2003)	2.5 GT/s	8b/10b	NRZ

(*Flit Mode also enabled in other Data Rate with their respective encoding).

^{**}The PCIe specifications are living documents and have multiple versions and Engineering Change Requests (ECNs).Refer to the PCI-SIG website for the most recent version.



PCI-SIG® Roadmap



PCIe® Speeds/Feeds - Pick Your Bandwidth

- Flexible to meet needs from handheld/client to server/HPC
- ~Max Total Bandwidth = Max RX bandwidth + Max TX bandwidth
- 35 Permutations yielding 11 unique bandwidth profiles
- Encoding overhead and header efficiency not included

Specifications	x1	x2	Lanes x4	x8	x16
2.5 GT/s (PCle 1.x +)	500 MB/S	1 GB/S	2 GB/S	4 GB/S	8 GB/S
5.0 GT/s (PCle 2.x +)	1 GB/S	2 GB/S	4 GB/S	8 GB/S	16 GB/S
8.0 GT/s (PCle 3.x +)	2 GB/S	4 GB/S	8 GB/S	16 GB/S	32 GB/S
16.0 GT/s (PCle 4.x +)	4 GB/S	8 GB/S	16 GB/S	32 GB/S	64 GB/S
32.0 GT/s (PCle 5.x +)	8 GB/S	16 GB/S	32 GB/S	64 GB/S	128 GB/S
64.0 GT/s (PCle 6.x +)	16 GB/S	32 GB/S	64 GB/S	128 GB/S	256 GB/S
128.0 GT/s (PCle 7.x +)	32 GB/S	64 GB/S	128 GB/S	256 GB/S	512 GB/S
256.0 GT/s (PCle 8.x +)	64 GB/S	128 GB/S	256 GB/S	512 GB/S	1TB/S

^{+ =} data rate supported by this and subsequent spec revisions.



Optical Aware Retimer Specification

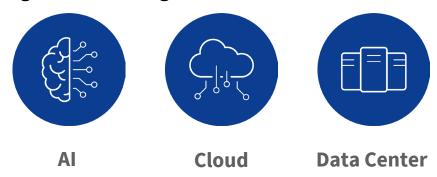
PCI-SIG® released the industry's first standard-based optical PCIe® solution to members on June 11, 2025

- Why did PCI-SIG develop an Optical Aware Retimer?
 - The objective of the Optical Work group has been to standardize optical PCIe architecture in a way that is easily transferred to
 existing PCIe 6.0 designs and devices and is included in the new PCIe 7.0 specification; experts from Logic, Protocol, Optical, and
 Electrical supported the creation of this solution

Optical Aware Retimer ECN

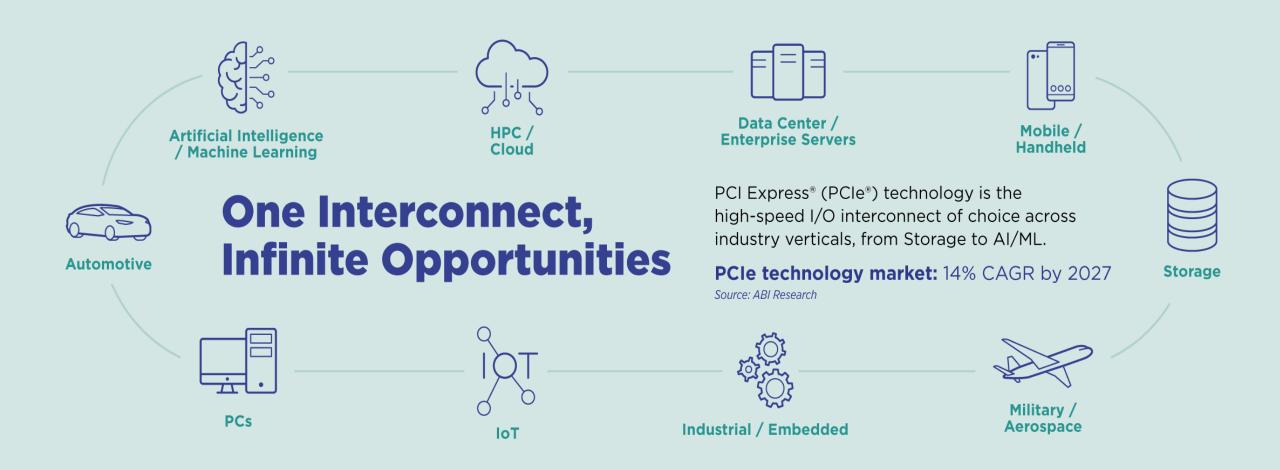
- Seamlessly enables various optical technologies for optical interconnection between existing PCIe 6.4 and 7.0 specification-compliant Switch, Root-Complex and Endpoint silicon designs
- Grants extended reach across racks and pods
- Allows multiplexing and data mapping across electrical and optical domains
- Enables more compact implementations than electrical copper solutions

Target Market Segments:





PCle® Architecture in Industry Verticals





Panel Members



Meet the Speakers



Sam Kocsis
Amphenol
Director of Standards and Technology

&

PCI-SIG Cabling Workgroup Chair



Ron Lowman
Synopsys
PCIe/CXL Product Management



Casey Morrison
Astera Labs
Chief Product Officer